

Electronic Acknowledgement Receipt

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| EFS ID: | 6470862 |
| Application Number: | 10540513 |
| International Application Number: | |
| Confirmation Number: | 6641 |
| Title of Invention: | Compound semiconductor epitaxial substrate and method for manufacturing the same |
| First Named Inventor/Applicant Name: | Takenori Osada |
| Customer Number: | 23373 |
| Filer: | Abraham Jacob Rosner/Kamila Williams |
| Filer Authorized By: | Abraham Jacob Rosner |
| Attorney Docket Number: | Q88662 |
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File Listing:

| Document Number | Document Description | File Name | File Size(Bytes)/Message Digest | Multi Part/.zip | Pages (if appl.) |
|-----------------|----------------------|----------------|--|-----------------|------------------|
| 1 | | Q88662_IDS.pdf | 116915 4c901ab769a685471ec60dca1b0dfaaf53ac 24/2 | yes | 4 |

| Multipart Description/PDF files in .zip description | | | | | |
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| | Transmittal Letter | | 1 | 2 | |
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| | Information Disclosure Statement (IDS) Filed (SB/08) | | 4 | 4 | |
| Warnings: | | | | | |
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| 2 | NPL Documents | Q88662_OA_pdf.pdf | 545513 c99e4ee4e4b541f8e81adda69ccb95c5612 540a4 | no | 6 |
| Warnings: | | | | | |
| Information: | | | | | |
| 3 | Foreign Reference | Q88662_JP609_pdf.pdf | 1689923 9206ac87f4f6e78ca4b0fea01b4e64cc4b6d 343e | no | 9 |
| Warnings: | | | | | |
| Information: | | | | | |
| 4 | Foreign Reference | Q88662_JP413_pdf.pdf | 1006448 7f6eb1e57c12e1399ad42398bfeaab267f27 9cf7 | no | 7 |
| Warnings: | | | | | |
| Information: | | | | | |
| 5 | Foreign Reference | Q88662_JP819_pdf.pdf | 1792533 f96cc82a2dc734736b888f06483a530638e0 8b97 | no | 9 |
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.